2SB0930 (2SB930), **2SB0930A** (2SB930A)

Silicon PNP epitaxial planar type

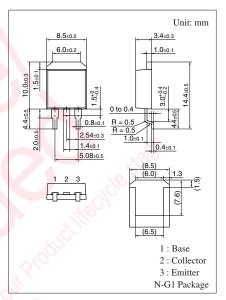
For power amplification Complementary to 2SD1253, 2SD1253A

■ Features

- High forward current transfer ratio h_{FE} which has satisfactory linearity
- \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB0930	V _{CBO}	-60	V
(Emitter open)	2SB0930A		-80	
Collector-emitter voltage	2SB0930	V _{CEO}	-60	V
(Base open)	2SB0930A		-80	
Emitter-base voltage (Coll	V _{EBO}	-5	V	
Collector current		I_{C}	-4	A
Peak collector current	I_{CP}	-8	A	
Collector power dissipation		P _C	40	W
	$T_a = 25^{\circ}C$		1.3	
Junction temperature	T_{j}	150	°C	
Storage temperature		T_{stg}	-55 to +150	S °C



Note) Self-supported type package is also prepared.

■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0930	V _{CEO}	$I_C = -30 \text{ mA}, I_B = 0$	-60	-0/1		V
(Base open)	2SB0930A			-80	53		
Collector-emitter cutoff	2SB0930	I _{CES}	$V_{CE} = -60 \text{ V}, V_{BE} = 0$	00)		-400	μΑ
current (E-B short)	2SB0930A		$V_{CE} = -80 \text{ V}, V_{BE} = 0$			-400	
Collector-emitter cutoff	2SB0930	I_{CEO}	$V_{CE} = -30 \text{ V}, I_{B} = 0$			-700	μΑ
current (Base open)	2SB0930A		$V_{CE} = -60 \text{ V}, I_B = 0$			-700	
Emitter-base cutoff current (Co	llector open)	I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-1	mA
Forward current transfer ratio		h _{FE1} *	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	70		250	_
		h _{FE2}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	15			
Base-emitter voltage		V_{BE}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$			-2.0	V
Collector-emitter saturation	voltage	V _{CE(sat)}	$I_C = -4 \text{ A}, I_B = -0.4 \text{ A}$			-1.5	V
Transition frequency		f_T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	$I_C = -4 A$,		0.2		μs
Storage time		t _{stg}	$I_{B1} = -0.4 \text{ A}, I_{B2} = 0.4 \text{ A}$		0.5		μs
Fall time		$t_{\rm f}$	$V_{CC} = -50 \text{ V}$		0.2		μs

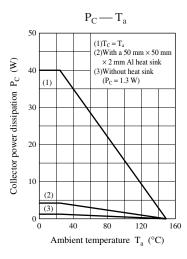
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

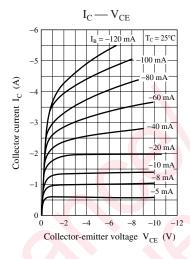
2. *: Rank classification

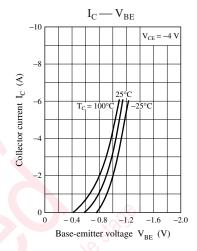
Rank	Q	Р		
$h_{\rm FE1}$	70 to 150	120 to 250		

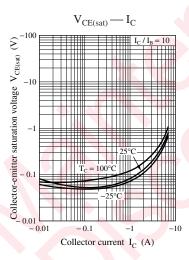
Note) The part number in the parenthesis shows conventional part number.

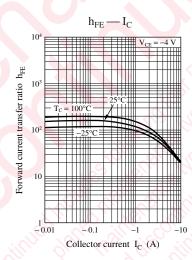
Panasonic

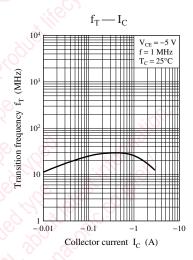


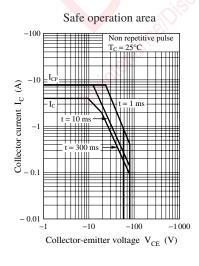


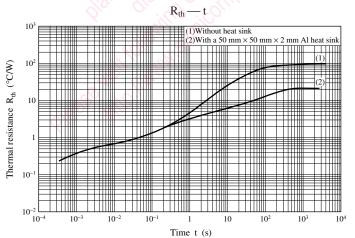












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